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# Radiation Induced Leakage Current and Electric Field Enhancement in CMOS Image Sensor Sense Node Floating Diffusions

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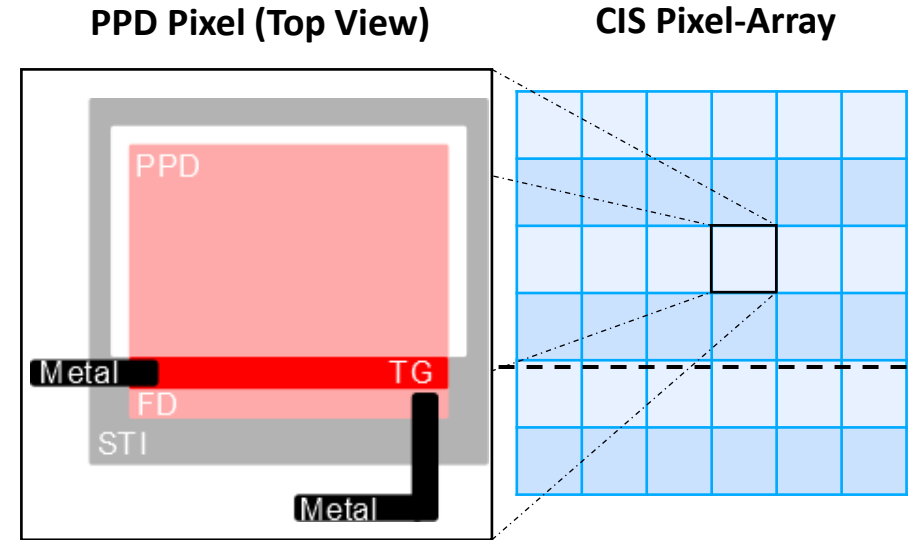
A. Le Roch, C. Virmontois, P. Paillet, J-M. Belloir, S. Rizzolo, F. Pace, C. Durnez,  
V. Goiffon.





# Context and Motivation

- CMOS Image Sensor (**CIS**): Pixel-array where transistors are integrated in the pixel.
- Pinned-PhotoDiode (**PPD**) CIS are more and more considered for **visible imaging in radiative environments**.
- **Leakage current sources** have been extensively studied in the PPDs.



**No study dedicated to the Floating Diffusions (FD) leakage current after irradiation.**



# Context and motivation: The role of the Floating Diffusion

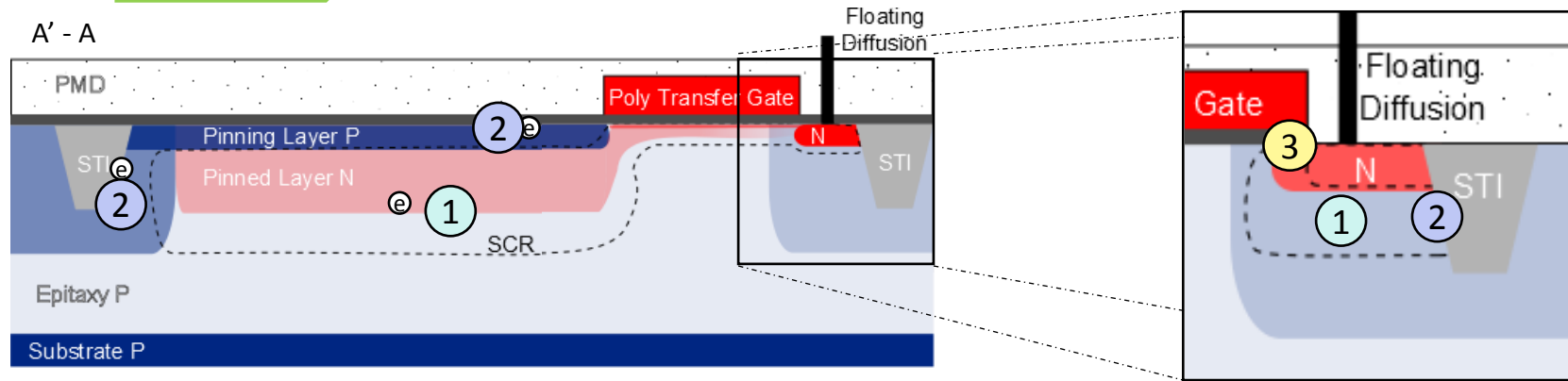
Integration

Transfer

Idle Time

Readout

PPD Pixel (Top View)



The same leakage current sources are expected to be found in both structures:

- ① Bulk defects
- ② Si/SiO<sub>2</sub> interface defects
- ③ Gate Induced Leakage (GIL)

The FD leakage current is more influential when long storage times are concerned.

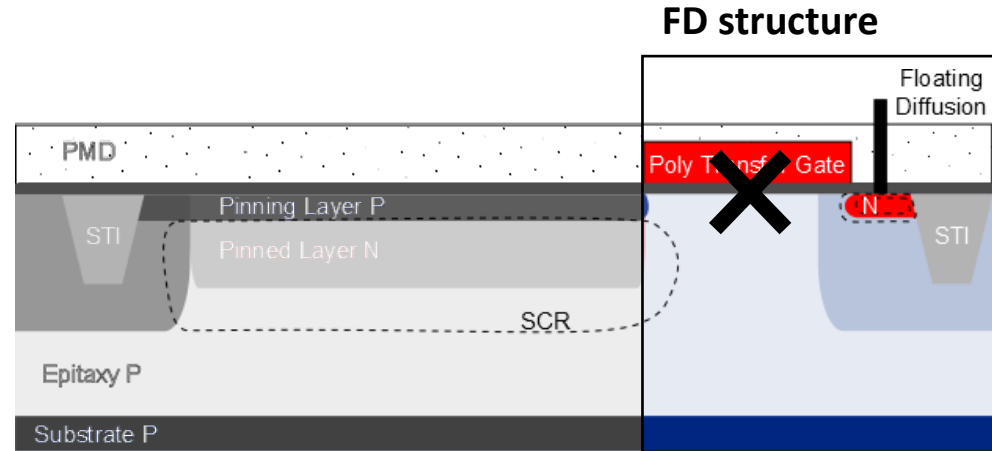
**Global Shutter CIS must consider the FD leakage current in radiative environments.**



# Experimental Details: Comparison PPD Vs FD

## CIS under test:

- 4T PPD
- Custom Imager designed at ISAE-SUPAERO
- Standard 0.18  $\mu\text{m}$  deep micron technology
- 512 x 512 pixels
- 7 $\mu\text{m}$  pitch
- PPD depleted volume 23  $\mu\text{m}^3$
- FD depleted volume 6  $\mu\text{m}^3$



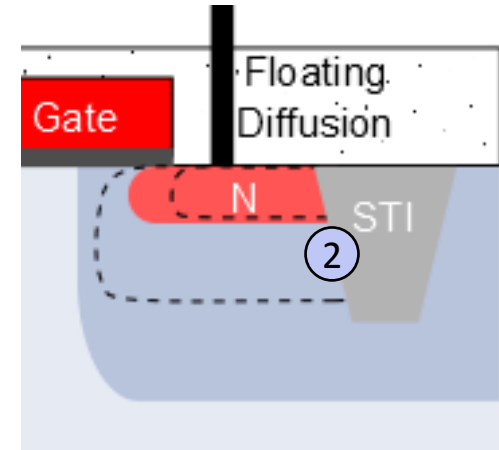
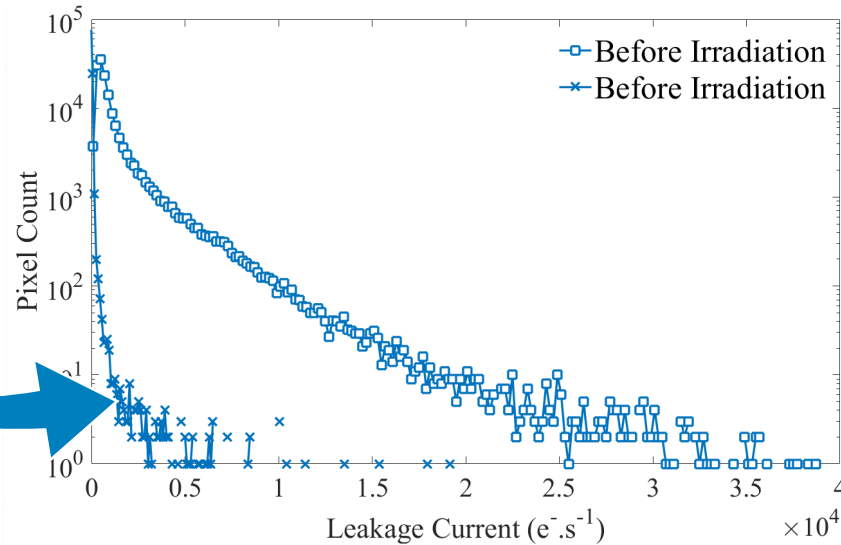
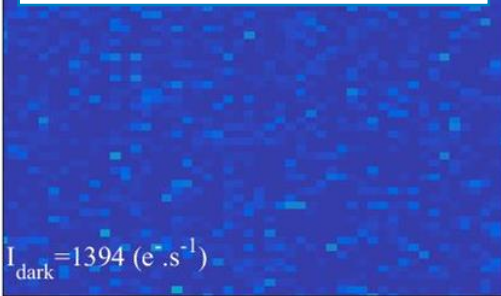
**FD study: Operated as a conventional 3T PD by closing the transfer gate.**

# Results: Before Irradiation

PPD Before Irradiation



FD Before Irradiation



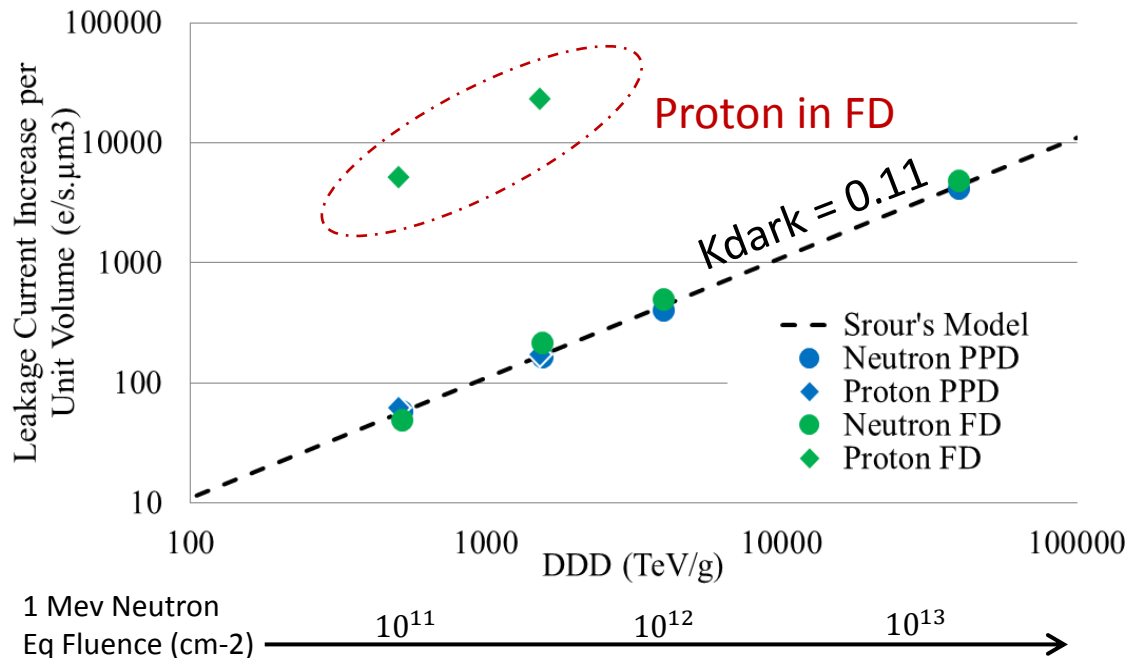
② Si/SiO<sub>2</sub> interface defects

- No bulk defect neither in PPD nor in FD before irradiation.
- Huge leakage current in the FD before irradiation coming from **Si/SiO<sub>2</sub> interface defects**.



# Results: After Neutron (22 Mev) and Proton (50 MeV) Irradiation

Prediction of the mean leakage current increase: Universal Dammage Factor (UDF).



## PPD:

- UDF model **works** for neutron and proton irradiations.
- **PPD not sensitive to TID** induced by protons (24 krad(SiO<sub>2</sub>)).

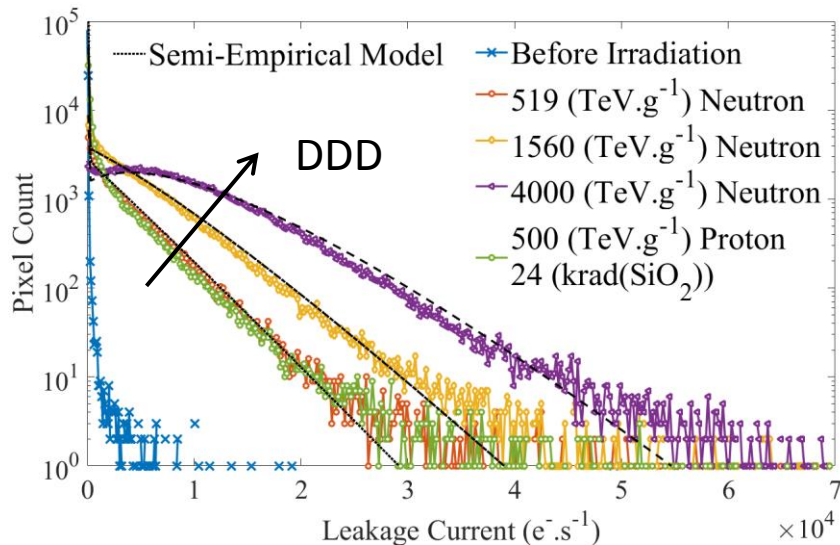
## FD:

- UDF model works for neutron
  - The FD structure has no influence on the model.
- UDF model **does not work** for proton irradiations.
  - **FD is sensitive to TID induced by protons.**

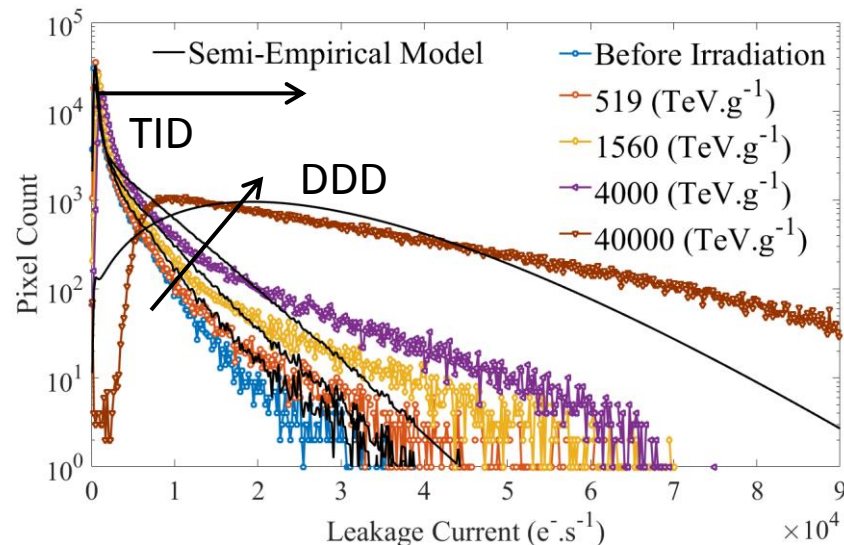


# Results: After Neutron (22 Mev) and Proton (50 MeV) Irradiation

## PPD



## FD



- Leakage current increase with the DDD.
- No impact of the TID induced by proton.
- Empirical exponential prediction (Belloir 2017) in agreement with the data.

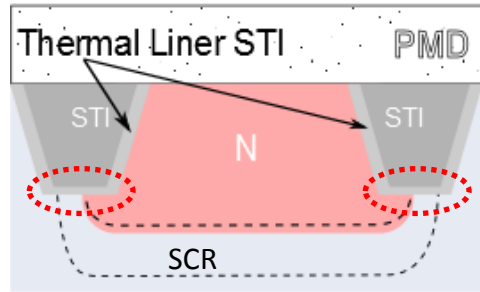
- Strong impact of the TID (proton / X-ray).
- Leakage current increase with the DDD.
- Empirical exponential prediction does not work.





# What makes the Floating Diffusion Different from 3T PD & 4T PPD

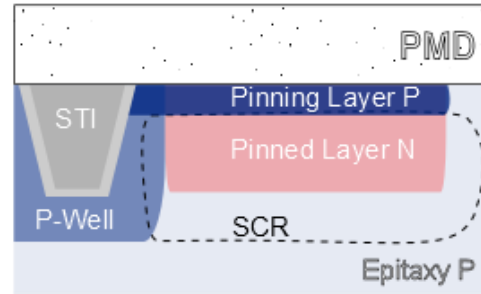
## 3T PD



\*Space Charge Region (SCR)

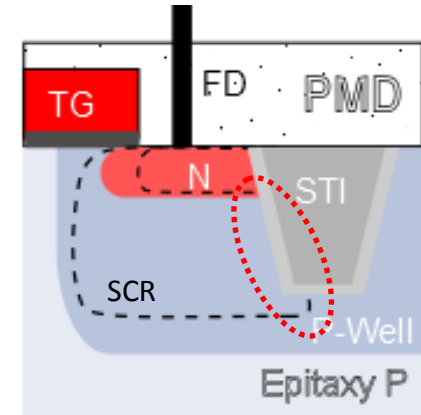
- Small STI / SCR contact area.
- Good interface quality.
- Low doping level / Low electric field.

## 4T PDD



- No STI / SCR contact area.
- Low doping level / Low electric field.

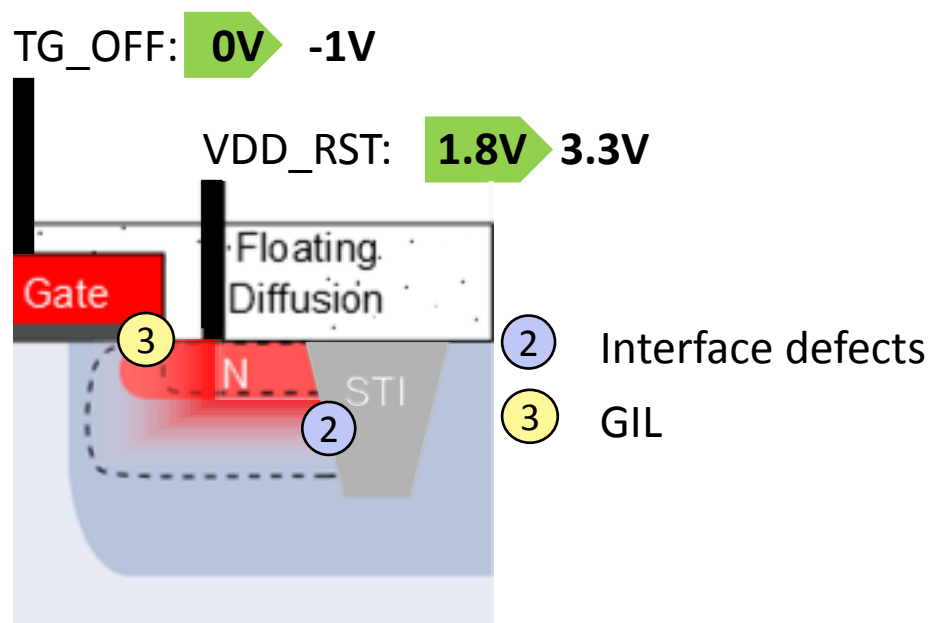
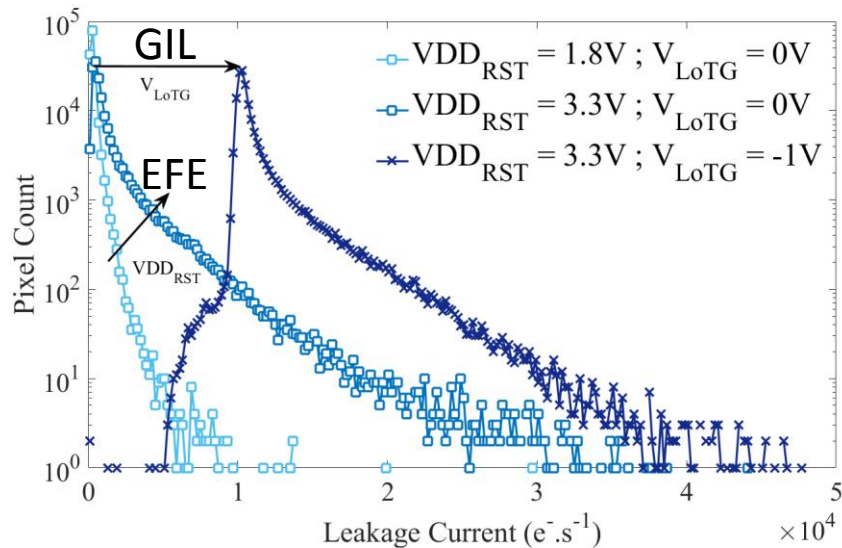
## FD



- Large STI / SCR contact area.
- Bad interface quality at the STI sidewalls.
- High doping level / High electric field.
- Contact with the STI corner ?

# Results: Leakage Current Distribution & Electric Field

## Before Irradiation in FD



- Electric Field Enhancement (EFE) of defects generation rates with the reset voltage.
  - Interface defects before irradiation.
- Gate Induced Leakage (GIL) current below the transfer gate.



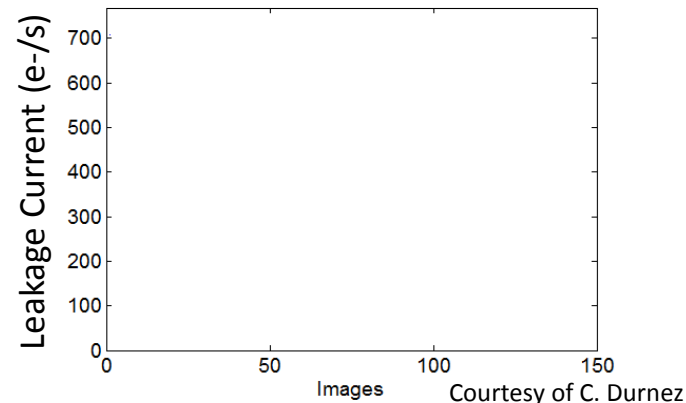
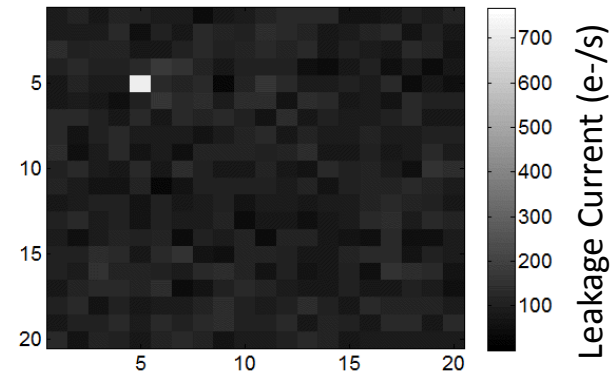
# RTS Leakage Current: Definition

## Leakage Current:

- Constant leakage current when no photon hits the CIS.

## Leakage Current Random Telegraph Signal

- Leakage current which switches **randomly** between two or more discrete levels with time.
- **Looks like a blinking pixel.**
- Calibration troubles.
- Typical **maximum transition amplitude** distribution

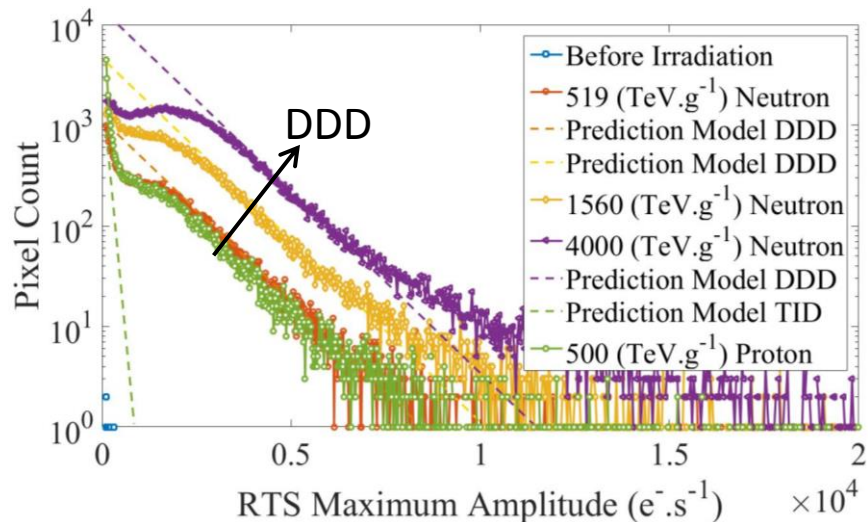


Courtesy of C. Durnez



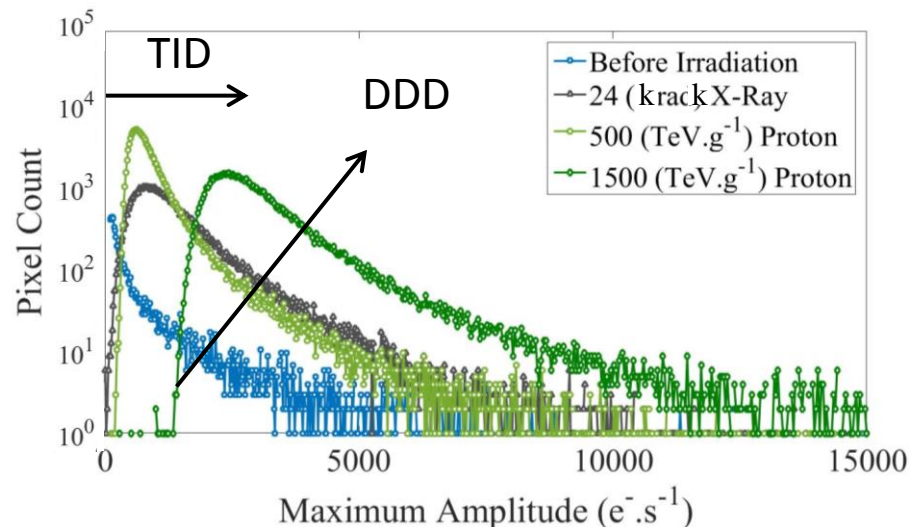
# Results: **RTS** Leakage Current

**PPD**



- RTS Leakage current increase with the DDD.
- RTS prediction model works.
- Small impact of the TID induced by protons.

**FD**

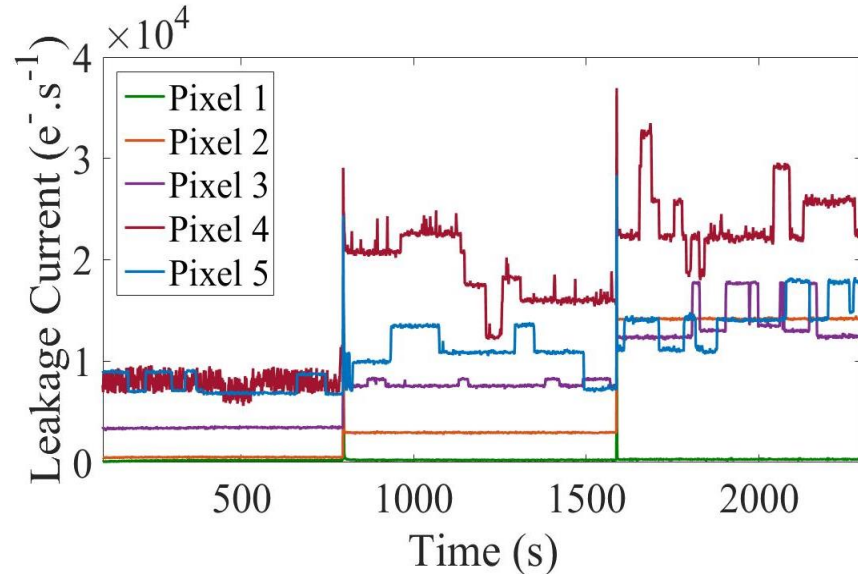


- RTS Leakage current increase with the DDD.
- **RTS prediction model does not work.**
- **Strong impact of the TID (proton / X-ray).**

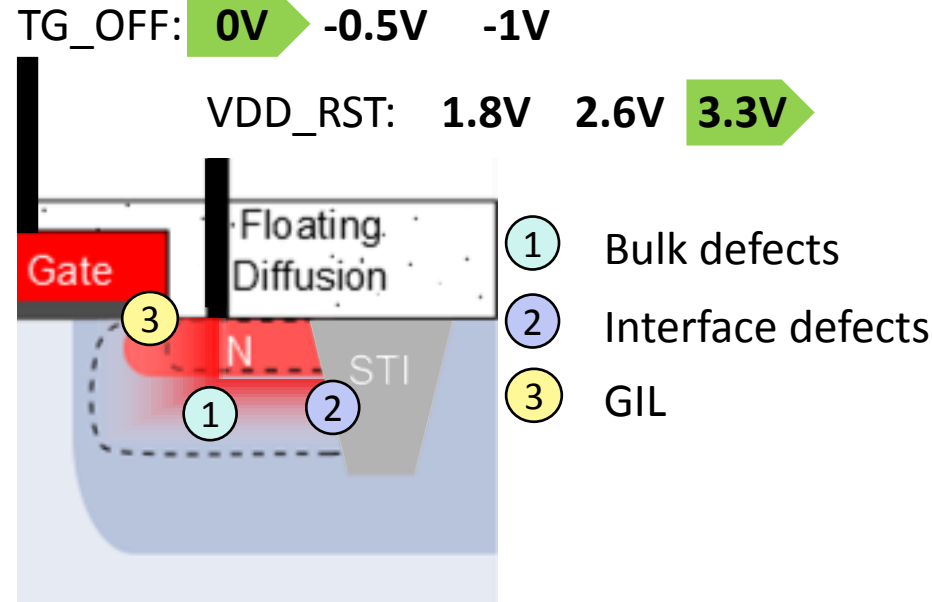


# Results: **RTS** Leakage Current & Electric Field

## Neutron in FD



- The **GIL** reveals some **RTS** centers which maximum transition amplitudes are enhanced by the induced electric field under the gate.



- The electric field into the FD junction enhances the defects maximum transition amplitudes.
- Pre-irradiation: only Interface defects.



# Conclusion: Radiation Effects on CIS Floating Diffusions

## Before irradiation:

- Interface defects coming from STI sidewalls dominate the FD leakage current.
- Some of them act as RTS centers.

## After Irradiation:

- FD leakage current is dominated by the TID induced defects (proton & X-ray).
- FD **leakage current distributions** reveal a population of pixels impacted by an Electric Field Enhancement (EFE).
- RTS centers are also impacted by the FD electric field.

## Consequences:

- The radiation induced FD leakage current has to be taken into account in Global Shutter CIS. It can prevent the use of global shutter image sensor in radiation environments.
- The conventional TID hardening techniques of PN junctions can be considered:  
Enclosed layout FD / buried channel FD



# Thank you for your attention!

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